

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JISOOK PAIK</td> <td>12/22/2013</td> </tr> <tr> <td>NAN HEE PAIK</td> <td>12/22/2013</td> </tr> <tr> <td>JI HYE PAIK</td> <td>12/22/2013</td> </tr> <tr> <td>JI WON SON</td> <td>12/22/2013</td> </tr> </tbody> </table>		Name	Execution Date	JISOOK PAIK	12/22/2013	NAN HEE PAIK	12/22/2013	JI HYE PAIK	12/22/2013	JI WON SON	12/22/2013
Name	Execution Date										
JISOOK PAIK	12/22/2013										
NAN HEE PAIK	12/22/2013										
JI HYE PAIK	12/22/2013										
JI WON SON	12/22/2013										
RECEIVING PARTY DATA											
Name:	WOOJIN PLASTIC CO. LTD.										
Street Address:	68, DAMTEO-GIL 21BEON-GIL										
City:	GURI-SI, GYEONGGI-DO										
State/Country:	KOREA, REPUBLIC OF										
Postal Code:	471-858										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>29477782</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	29477782						
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Application Number:	29477782										
CORRESPONDENCE DATA											
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<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>											
Correspondent Name:	NOVICK, KIM & LEE, PLLC										
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ATTORNEY DOCKET NUMBER:	DK002130529										
NAME OF SUBMITTER:	HYUN WOO SHIN										
Signature:	/Hyun Woo Shin/										

Date:

12/26/2013

Total Attachments: 2

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### ASSIGNMENT

WHEREAS, **Jisook PAIK**, whose post office address is 108-403 LG Zai Apartment, Icheon-dong, Yongsan-gu, Seoul 140-774 Republic of Korea, **Nan Hee PAIK**, whose post office address is 111-603 Hanbo-Mido Mansion, 511 Daechi-dong, Gangnam-gu, Seoul 135-837 Republic of Korea, **Ji Hye PAIK**, whose post office address is 20-404 Hyundai APT., 369-1 Apgujeong-dong, Gangnam-gu, Seoul 135-787 Republic of Korea, and **Ji Won SON**, whose post office address is 109-609 LG Zai Apartment, Icheon-dong, Yongsan-gu, Seoul 140-774 Republic of Korea, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to a

### HOOK FOR TENT

for which they have executed, on the same date as this assignment, an application for Letters Patent of the United States which will be filed in the United States Patent and Trademark Office.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the attorneys or agents of record in this application, including Steve Jaeyoun Kim, Reg. No. 69,215, of the firm Novick, Kim & Lee, PLLC, whose address is 1604 Spring Hill Road, Suite 240, Vienna, VA 22182 to insert here in parenthesis (Application No. 29/477,782 (inserted after signing), filed December 26, 2013 (inserted after signing)) the filing date and application number of said application when known.

AND WHEREAS, **WOJIN PLASTIC CO. LTD.**, a corporation organized and existing under the laws of REPUBLIC OF KOREA, whose post-office address is 68, Damteo-gil 21beon-gil, Guri-si, Gyeonggi-do 471-858 Republic of Korea, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as a

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ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

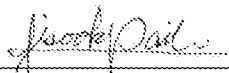
AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this Assignment is executed by said ASSIGNORS.

Jisook PAIK

Printed Name



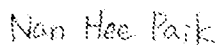
Signature

2013-12-22

Date

Nan Hee PAIK

Printed Name



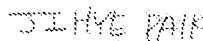
Signature

2013-12-22

Date

Ji Hye PAIK

Printed Name



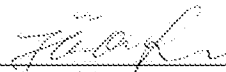
Signature

2013-12-22

Date

Ji Won SON

Printed Name



Signature

2013-12-22

Date